

L Number	Hits	Search Text	DB	Time stamp
1	3352	(dummy or monitor or test) same etch\$4 same (endpoint\$4 or rate or etchrate or target or depth or correlat\$4 or relation\$4 or equat\$4 or end-point\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 11:54
2	211	((dummy or monitor or test) same etch\$4 same (endpoint\$4 or rate or etchrate or target or depth or correlat\$4 or relation\$4 or equat\$4 or end-point\$3)) and (216/12.ccls. or 216/60.ccls. or 216/85.ccls. or 438/8.ccls. or 438/9.ccls. or 438/16.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 11:55
3	157	((dummy or monitor or test) same etch\$4 same (endpoint\$4 or rate or etchrate or target or depth or correlat\$4 or relation\$4 or equat\$4 or end-point\$3)) and (216/12.ccls. or 216/60.ccls. or 216/85.ccls. or 438/8.ccls. or 438/9.ccls. or 438/16.ccls.) and (reflect\$4 or refract\$4 or laser or illuminat\$4 or uv or ultraviolet or irradiat\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/28 11:56